

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7791795

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JAE YOON KIM	07/20/2011
JIN BOCK LEE	07/20/2011
SEOK MIN HWANG	07/20/2011
SU YEOL LEE	07/20/2011
RECEIVING PARTY DATA	
Name:	SAMSUNG LED CO., LTD.
Street Address:	314 MAETAN 3-DONG, YEONGTONG-GU, SUWON
City:	GYUNGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13225979
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NAME OF SUBMITTER:	MONIQUE BLAKEY
SIGNATURE:	/Monique Blakey/
DATE SIGNED:	02/10/2023
Total Attachments: 1 source=ASSIGNMENT#page1.tif	

(SAB)

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) KIM, Jae Yoon (5) _____
- (2) LEE, Jin Bock (6) _____
- (3) HWANG, Seok Min (7) _____
- (4) LEE, Su Yeol (8) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto
SAMSUNG LED CO., LTD.

314 Maetan 3-dong, Yeongtong-gu, Suwon, Gyeonggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SEMICONDUCTOR LIGHT EMITTING DEVICE AND MANUFACTURING METHOD THEREOF

(a) for which an application for United States Letters Patent was filed on _____ and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____ and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

1) KIM Jae Yoon _____ 2011. 7. 20
Name: KIM, Jae Yoon

2) Lee Jin Bock _____ 2011. 7. 20
Name: LEE, Jin Bock

3) HWANG Seok Min _____ 2011. 7. 20
Name: HWANG, Seok Min

4) Lee Su yeol _____ 2011. 7. 20
Name: LEE, Su Yeol

PATENT